

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1  
Stylesheet Version v1.2

EPAS ID: PAT8084382

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
SUNGOH KIM	07/25/2023
CHOELMIN PARK	07/26/2023
JAERYUNG YEO	07/26/2023
CHUNGWAN HONG	07/26/2023
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	SAMSUNG ELECTRONICS CO., LTD.
<b>Street Address:</b>	129, SAMSUNG-RO, YEONGTONG-GU, GYEONGGI-DO
<b>City:</b>	SUWON-SI
<b>State/Country:</b>	KOREA, REPUBLIC OF
<b>Postal Code:</b>	16677
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
Application Number:	18227605
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	(202)293-7860
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
<b>Phone:</b>	202-293-7060
<b>Email:</b>	sughrue@sughrue.com, coparaugo@sughrue.com
<b>Correspondent Name:</b>	SUGHRUE MION, PLLC
<b>Address Line 1:</b>	2000 PENNSYLVANIA AVENUE, N.W.
<b>Address Line 2:</b>	SUITE 9000
<b>Address Line 4:</b>	WASHINGTON, D.C. 20006
<b>ATTORNEY DOCKET NUMBER:</b>	Q288717
<b>NAME OF SUBMITTER:</b>	CHARISMA OPARAUGO
<b>SIGNATURE:</b>	/Charisma Oparaugo/
<b>DATE SIGNED:</b>	07/28/2023
	This document serves as an Oath/Declaration (37 CFR 1.63).
<b>Total Attachments: 2</b>	

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**PATENT**

**REEL: 064421 FRAME: 0739**



<b>NAME OF SOLE OR FIRST INVENTOR:</b>	
Given Name (first and middle [if any]) Sungoh	Family Name or Surname KIM
Inventor's signature <i>Sungoh Kim</i>	Date Jul 25, 2023
Residence: Suwon-si, Republic of Korea	
Mailing Address: 129, Samsung-ro, Yeongtong-gu, Suwon-si, Gyeonggi-do, 16677, Republic of Korea	
<b>NAME OF SECOND INVENTOR:</b>	
Given Name (first and middle [if any]) Choelmin	Family Name or Surname PARK
Inventor's signature <i>Choelmin Park</i>	Date Jul 26, 2023
Residence: Suwon-si, Republic of Korea	
Mailing Address: 129, Samsung-ro, Yeongtong-gu, Suwon-si, Gyeonggi-do, 16677, Republic of Korea	
<b>NAME OF THIRD INVENTOR:</b>	
Given Name (first and middle [if any]) Jaeyung	Family Name or Surname YEO
Inventor's signature <i>Jaeyung Yeo</i>	Date Jul 26, 2023
Residence: Suwon-si, Republic of Korea	
Mailing Address: 129, Samsung-ro, Yeongtong-gu, Suwon-si, Gyeonggi-do, 16677, Republic of Korea	
<b>NAME OF FOURTH INVENTOR:</b>	
Given Name (first and middle [if any]) Chungwan	Family Name or Surname HONG
Inventor's signature <i>Chungwan Hong</i>	Date Jul 26, 2023
Residence: Suwon-si, Republic of Korea	
Mailing Address: 129, Samsung-ro, Yeongtong-gu, Suwon-si, Gyeonggi-do, 16677, Republic of Korea	